Docket No.:

DECLARATION AND POWER OF ATTORNEY

As a below named inventor	, I hereby declare that:		
My residence, post office ar	nd citizenship are as stated l	below next to my name,	•
_	ect matter claimed and for	which a patent is sought on the inve	riginal, first and joint inventor (if plural names ention entitled HEATING
[X] is attached hereto	[] was filed on	as Application Serial N	No and was
	amended on	(if applic	able)
including the claims, as ame			ents of the above identified specification,
accordance with Title 37, C			wn to me to be material to patentability in
United States of America, li	ificate, or 365(a) of any PC sted below and have also ic	T international application which de lentified below, by checking the box	(a)-(d) or 365 (b) of any foreign application(s) is ignated at least one country other than the standard application for patent or at of the application on which priority is
Prior Foreign Application Number	n(s):	Country	Foreign Filing Date Month/Day/Year
2003/37966		Korea	June 12, 2003
I hereby claim the benefit u	nder 35 U.S.C. 119(e) of an	ny United States provisional applicat	ion(s) listed below.
Application Number(s):	Number(s): Filing Date (Month/Day/Year)		h/Day/Year)
designating the United Stat disclosed in the prior Unite acknowledge the duty to o	es of America, listed beloved Ed States or PCT internation disclose information which	v and, insofar as the subject matter onal application in the manner prov	or 365(c) of any PCT international application of each of the claims of this application is not yided by the first paragraph of 35 U.S.C. 112, I fined in 37 CFR 1.56 which became available date of this application.
Prior U. S. Application r PCT Parent Number	Fil	ling Date (Month/Day/Year)	Parent Patent Number (if applicable)
I hereby declare that all stat	ements made herein of my	own knowledge are true and that al	l statements made on information and belief are

statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Carol L. Druzbick, Registration No. 40,287; Anthony H. Nourse, Registration No. 46,121; Laura L. Lee, Registration No. 48,752; Rene A. Vazquez, Registration No. 38,647; Donald R. McPhail, Registration No. 35,811; Timothy M. Speer, Registration No. 47,355; Samuel W. Ntiros, Registration No. 39,318; Mark R. Buscher, Registration No. 35,006; and Daniel H. Sherr, Registration No. 46,425, all of

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with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and all future correspondence should be addressed to them.

Full name of sole or first inventor: Young Min LEE Inventor's signature: Date: D	*************************************
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